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DBL146
9-3-01

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Eiko Suzuki **Examiner:** John Donaldson

Serial No.: 09/828,003 **Art Unit:** 2621

Filed: April 6, 2001 **Docket:** 14467

For: ID RECOGNITION APPARATUS
AND ID RECOGNITION SORTER
SYSTEM FOR SEMICONDUCTOR WAFER **Dated:** August 30, 2001

Assistant Commissioner for Patents
Washington, D.C. 20231

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INFORMATION DISCLOSURE STATEMENT

Sir:

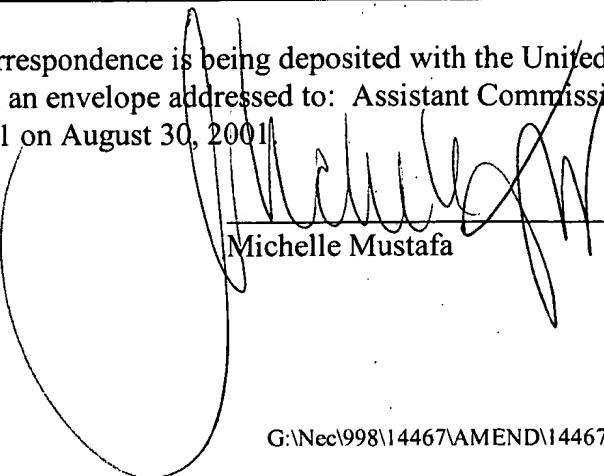
In accordance with 37 C.F.R. §§1.97 and 1.98, it is requested that the following reference, which is also listed on the attached Form PTO-1449, be made of record in the above-identified case.

1. Japanese Laid-Open Patent Publication No. 2000-55820, published February 25, 2000, together with an English-Language Abstract and Japanese Patent Office translation.

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231 on August 30, 2001.

Dated: August 30, 2001


Michelle Mustafa

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The reference was cited in a Search Report received from the United Kingdom Patent Office. Applicant is submitting a copy of the above-cited reference, together with a copy of the Search Report. The relevance of the above-identified reference has been described in the Search Report.

Inasmuch as this Information Disclosure Statement is being submitted in accordance with the schedule set out in 37 C.F.R. § 1.97(b), no statement or fee is required.

Respectfully submitted,


Paul J. Esatto, Jr.
Registration No. 30,749

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(516) 742-4343

PJE:dg

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT
(Under 37 CFR 1.97(b) or 1.97(c))

Docket No.
14467

In Re Application Of: **Eiko Suzuki**

Serial No.
09/828,003

Filing Date
April 6, 2001

Examiner
John Donaldson

Group Art Unit
2621

Title:

ID RECOGNITION APPARATUS AND ID RECOGNITION SORTER SYSTEM FOR SEMICONDUCTOR WAFER

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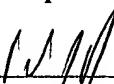
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Michelle Mustafa

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Signature

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PJE:dg

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TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT
(Under 37 CFR 1.97(b) or 1.97(c))

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In Re Application Of: **Eiko Suzuki**

Serial No.
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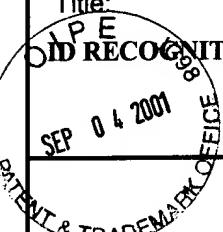
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37 CFR 1.97(b)

1. The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application; within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; or before the mailing date of a first Office Action on the merits, whichever event occurs last.

37 CFR 1.97(c)

2. The Information Disclosure Statement submitted herewith is being filed after three months of the filing of a national application, or the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; or after the mailing date of a first Office Action on the merits, whichever occurred last but before the mailing date of either:

1. a Final Action under 37 CFR 1.113, or
2. a Notice of Allowance under 37 CFR 1.311,

whichever occurs first.

Also submitted herewith is:

a certification as specified in 37 CFR 1.97(e);

OR

the fee set forth in 37 CFR 1.17(p) for submission of an Information Disclosure Statement under 37 CFR 1.97(c).